



32V, 2A, Synchronous DC/DC Buck Converter With Enhanced EMI Reduction

DESCRIPTION

The AP63205 is a 2A, synchronous buck converter with a wide input voltage range of 3.8V to 32V and fully integrates a $125m\Omega$ high-side power MOSFET and a $68m\Omega$ low-side power MOSFET to provide high-efficiency step-down DC/DC conversion.

The AP63205 device is easily used by minimizing the external component count due to its adoption of peak current mode control along with its integrated compensation network.

The AP63205 is fixed output buck converters with Electromagnetic Interference (EMI) reduction. The converter features Frequency Spread Spectrum (FSS)

with a switching frequency jitter of ±6%, which reduces EMI by not allowing emitted energy to stay in any one frequency for a significant period of time. It also has a proprietary gate driver scheme to resist switching node ringing without sacrificing MOSFET turn-on and turn-off times, which further reduces high-frequency radiated EMI noise caused by MOSFET switching.

The device is available in a low-profile, TSOT26 package.

FEATURES

- VIN 3.8V to 32V
- 2A Continuous Output Current
- 0.8V ± 1% Reference Voltage
- 22μA Ultralow Quiescent Current (Pulse Frequency Modulation)
- 1.1MHz Switching Frequency
- Supports Pulse Frequency Modulation (PFM) and Pulse Width Modulation (PWM)
- Proprietary Gate Driver Design for Best EMI Reduction

- Frequency Spread Spectrum (FSS) to Reduce EMI
- Low-Dropout (LDO) Mode
- Precision Enable Threshold to adjust UVLO
- Protection Circuitry
 - Undervoltage Lockout (UVLO)
 - Cycle-by-Cycle Peak
 Current Limit
 - Thermal Shutdown



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APPLICATIONS

- 12V and 24V Distributed Power Bus Supplies
- Flat Screen TV Sets and Monitors
- Power Tools and Laser Printers
- White Goods and Small Home Appliances
- FPGA, DSP, and ASIC Supplies
- Home Audio
- Network Systems
- Set Top Boxes
- Gaming Consoles
- Consumer Electronics

FUNCTIONAL BLOCK

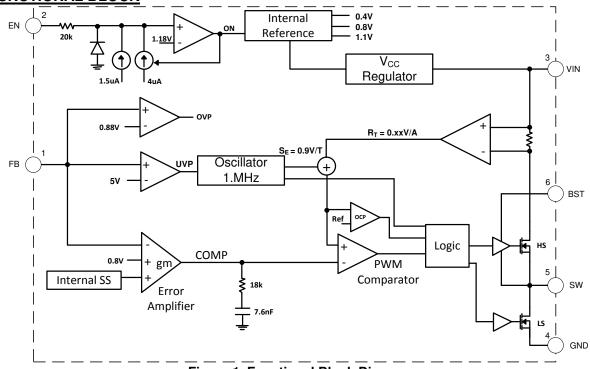


Figure 1. Functional Block Diagram

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating	Unit	
VIN	Supply Voltage	-0.3 to +35.0 (DC)	V	
VIIN		-0.3 to +40.0 (400ms)		
V _{SW}	Switch Node Voltage	-1.0 to VIN + 0.3 (DC)	V	



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		-2.5 to VIN + 2.0 (20ns)			
V _{BST}	Bootstrap Voltage	V_{SW} - 0.3 to V_{SW} + 6.0	V		
V_{FB}	Feedback Voltage	-0.3 to +6.0	V		
V _{EN}	Enable/UVLO Voltage	-0.3 to +35.0	V		
T _{ST}	Storage Temperature	-65 to +150	°C		
T _J	Junction Temperature	+150	°C		
T_L	Lead Temperature	+260	°C		
ESD Susceptibility					
HBM	Human Body Mode	2000	V		
CDM	Charge Device Model	1000	V		

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
VIN	Supply Voltage	3.8	32	V
T _A	Operating Ambient Temperature Range	-40	+85	°C
T _J	Operating Junction Temperature Range	-40	+125	°C

EVALUATION BOARD

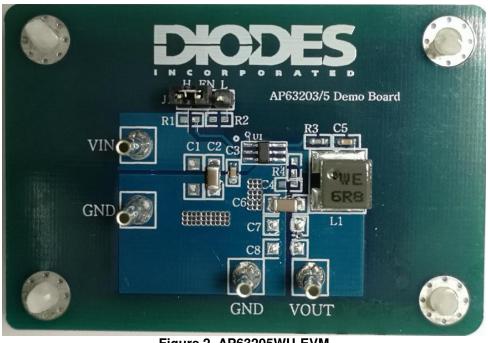


Figure 2. AP63205WU-EVM

AP63205WU-EVM



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QUICK START GUIDE

The AP63205WU-EVM has a simple layout and allows access to the appropriate signals through test points. To evaluate the performance of the AP63205WU, follow the procedure below:

- 1. For evaluation board configured at V_{OUT}=5.0V, connect a power supply to the input terminals V_{IN} and GND. Set V_{IN} to 12V.
- 2. Connect the positive terminal of the electronic load to Vout and negative terminal to GND.
- 3. For Enable, place a jumper to "H" position to enable IC. Jump to "L" position to disable IC.
- 4. The evaluation board should now power up with a 5.0V output voltage.
- 5. Check for the proper output voltage of 5.0V (±1%) at the output terminals VouT and GND. Measurement can also be done with a multimeter with the positive and negative leads between VouT and GND.
- 6. Set the load to 2A through the electronic load. Check for the stable operation of the SW signal on the oscilloscope. Measure the switching frequency.

MEASUREMENT/PERFORMANCE GUIDELINES:

- 1) When measuring the output voltage ripple, maintain the shortest possible ground lengths on the oscilloscope probe. Long ground leads can erroneously inject high frequency noise into the measured ripple.
- 2) For efficiency measurements, connect an ammeter in series with the input supply to measure the input current. Connect an electronic load to the output for output current.

SETTING OUTPUT VOLTAGE:

Setting the output voltage

The AP63205 is fixed output buck converters; the output voltage is 5V.connect VFB pin to output directly as schematic shown,



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EVALUATION BOARD SCHEMATIC

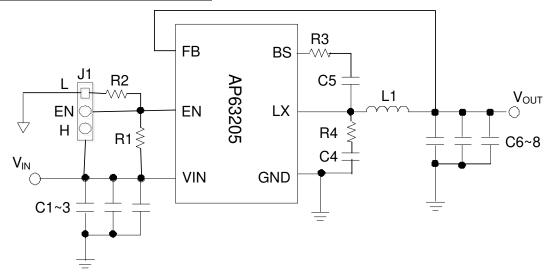


Figure 3. AP63205WU-EVM Schematic

BILL OF MATERIALS for AP63205WU-EVM (Vout=5.0V)

Item	Value	Type	Rating	Description	Description
C2	10uF	X5R/X7R, Ceramic/1206	35V	Input CAP	
C3	0.1uF	X5R/X7R, Ceramic/0603	50V	Input CAP	Würth PART 885 012 206 095
C4	100pF	0603	100V	Feedback CAP	Würth PART 885 012 206 102
C5	0.1uF	X5R/X7R, Ceramic/0603	50V	Bootstrap CAP	Würth PART 885 012 206 095
C6 & C7	22uF	X5R/X7R, Ceramic/1206	25V	Output CAP	
L1	6.8uH	6060	5.0A	Inductor	Würth PART 744 393 460 68
R3	0	0603	1%	Bootstrap RES	
U1		AP63205WU		TSOT26	Diodes Inc



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TYPICAL PERFORMANCE CHARACTERISTICS

Figure 4. Efficiency for VIN=12V, VOUT= 5.0V

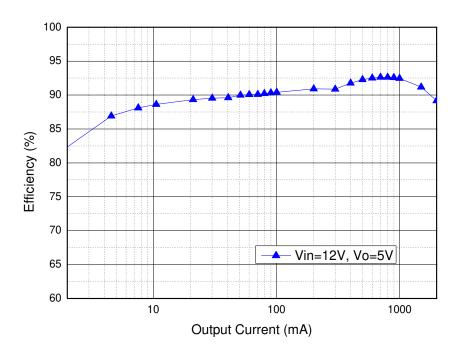
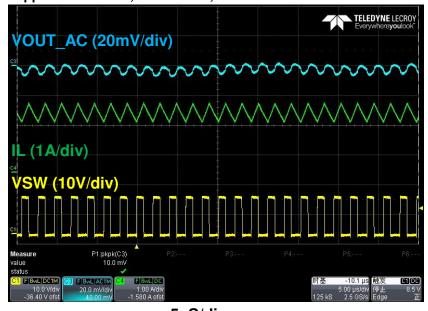


Figure 5. Output Ripple for VIN=12V, VOUT=5.0V, IOUT=2A



5µS/div

AP63205WU-EVM



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